5-534998-5 ACTIVE

AMPMODU | Modu Connector System

TE Internal #: 5-534998-5

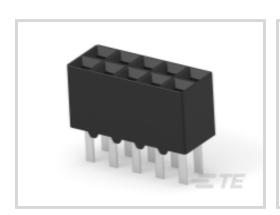
PCB Mount Receptacle, Vertical, Board-to-Board, 10 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu

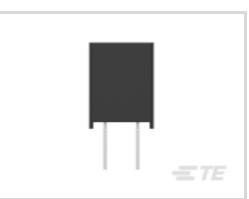
Connector System

View on TE.com >

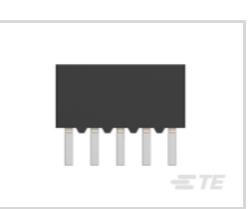


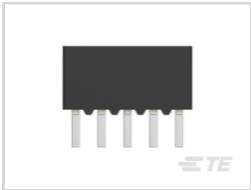
Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 10

Number of Rows: 2

Features

Product Type Features

| Applied Pressure | Standard |
|-----------------------------------|-----------------------|
| PCB Connector Type | PCB Mount Receptacle |
| Connector System | Board-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Connector Product Type | Connector Assembly |

Configuration Features

| Board-to-Board Configuration | Parallel |
|------------------------------|----------|
| Stackable | Yes |
| PCB Mount Orientation | Vertical |
| Number of Positions | 10 |
| Number of Rows | 2 |

Electrical Characteristics

| Operating Voltage | 333 VAC |
|-------------------|---------|
|-------------------|---------|



| Insulation Resistance | 5000 ΜΩ |
|---|-----------------------|
| Dielectric Withstanding Voltage (Max) | 750 VAC |
| Body Features | |
| Connector Profile | Low |
| Primary Product Color | Black |
| Contact Features | |
| Contact Mating Area Plating Material Thickness | .762 μm[30 μin] |
| Mating Square Post Dimension | .64 mm[.025 in] |
| PCB Contact Termination Area Plating Material Thickness | 3.81 – 7.62 µm |
| Contact Shape & Form | Round |
| Contact Protection Type | Closed Entry Housing |
| Contact Mating Area Length | 3.77 mm[.148 in] |
| Contact Base Material | Phosphor Bronze |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Mating Area Plating Material | Gold (Au) |
| Contact Type | Socket |
| Contact Current Rating (Max) | 2 A |
| Termination Features | |
| Rectangular Termination Post & Tail Width | .7 mm[.028 in] |
| Rectangular Termination Post & Tail Thickness | .2 mm[.008 in] |
| Termination Post & Tail Length | 3.18 mm[.125 in] |
| Termination Method to PCB | Through Hole - Solder |
| Mechanical Attachment | |
| PCB Mount Retention | Without |
| PCB Mount Alignment | Without |
| Connector Mounting Type | Board Mount |
| Mating Alignment | Without |
| Housing Features | |
| Mating Entry Location | Тор |
| Housing Material | Thermoplastic |
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Dimensions | |



| Row-to-Row Spacing | 2.54 mm[.1 in] |
|-----------------------------|-------------------------|
| Stack Height | 9.02 mm[.355 in] |
| PCB Thickness (Recommended) | 1.57 mm[.055 – .094 in] |
| Connector Height | 5.03 mm[.198 in] |

Usage Conditions

| Housing Temperature Rating | Standard |
|-----------------------------|----------------------------|
| Operating Temperature Range | -65 – 125 °C[-85 – 257 °F] |

Operation/Application

| Solder Process Feature | Board Standoff |
|------------------------|----------------|
| Circuit Application | Signal |

Industry Standards

| Compatible With Approved Standards Products | CSA LR7189, UL E28476 |
|---|-----------------------|
| UL Flammability Rating | UL 94V-0 |

Packaging Features

| Packaging Quantity | 45 |
|--------------------|-----------|
| Packaging Method | Box, Tube |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Wave solder capable to 265°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products



will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Modu Connector System



Board-to-Board Headers & Receptacles(814)



Board-to-Board Jumpers & Shunts(5)

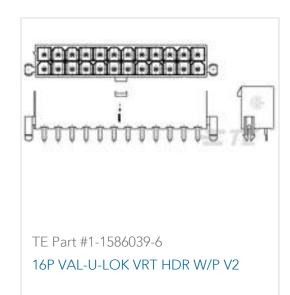


Connector Hardware(4)



PCB Headers & Receptacles(814)

Customers Also Bought





















TE Part #5-146130-3
08 MODII HDR DRST SFMNT B/A LF



Documents

Product Drawings

10 MODIV VRT DR CE 100/125

English

CAD Files

Customer View Model

ENG_CVM_CVM_5-534998-5_R.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-534998-5_R.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-534998-5_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English

Product Specifications

Application Specification

English